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April 1st, 2010 Renesas Electronics Corporation

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MOS FIELD EFFECT TRANSISTOR $\mu PA1901$

N-CHANNEL MOS FIELD EFFECT TRANSISTOR FOR SWITCHING

DESCRIPTION

The μ PA1901 is a switching device, which can be driven directly by a 2.5 V power source.

This device features a low on-state resistance and excellent switching characteristics, and is suitable for applications such as power switch of portable machine and so on.

FEATURES

- 2.5 V drive available
- Low on-state resistance $R_{DS(on)1} = 39 \text{ m}\Omega \text{ MAX}. (V_{GS} = 4.5 \text{ V}, I_D = 3.5 \text{ A})$

ORDERING INFORMATION

PART NUMBER	PACKAGE		
μΡΑ1901ΤΕ	SC-95 (Mini Mold Thin Type)		

Marking : TQ

ABSOLUTE MAXIMUM RATINGS ($T_A = 25^{\circ}C$)

Drain to Source Voltage ($V_{GS} = 0 V$)	VDSS	30	V
Gate to Source Voltage (VDS = 0 V)	Vgss	±12	V
Drain Current (DC) (T _A = 25°C)	D(DC)	±6.5	А
Drain Current (pulse) Note1	D(pulse)	±26	А
Total Power Dissipation	P _{T1}	0.2	W
Total Power Dissipation Note2	Рт2	2.0	W
Channel Temperature	Tch	150	°C
Storage Temperature	Tstg	–55 to +150	°C

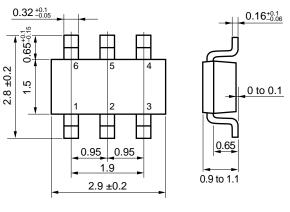
Notes 1. PW \leq 10 μ s, Duty Cycle \leq 1%

- **2.** Mounted on FR-4 board, $t \le 5$ sec.
- **Remark** The diode connected between the gate and source of the transistor serves as a protector against ESD. When this device actually used, an additional protection circuit is externally required if a voltage exceeding the rated voltage may be applied to this device.

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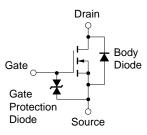
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PACKAGE DRAWING (Unit : mm)



1, 2, 5, 6 : Drain 3 : Gate 4 : Source

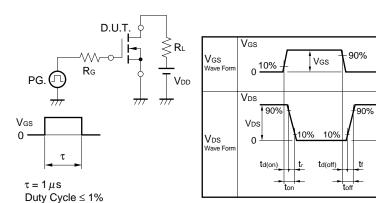
EQUIVALENT CIRCUIT



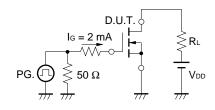
ELECTRICAL CHARACTERISTICS (TA = 25°C)

CHARACTERISTICS	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Zero Gate Voltage Drain Current	IDSS	$V_{DS} = 30 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$			10	μA
Gate Leakage Current	lgss	$V_{GS} = \pm 12 \text{ V}, \text{ V}_{DS} = 0 \text{ V}$			±10	μA
Gate to Source Cut-off Voltage	V _{GS(off)}	$V_{DS} = 10 \text{ V}, \text{ I}_{D} = 1.0 \text{ mA}$	0.5	1.0	1.5	V
Forward Transfer Admittance	y _{fs}	V _{DS} = 10 V, I _D = 3.5 A	3.0	7.9		S
Drain to Source On-state Resistance	RDS(on)1	Vgs = 4.5 V, Id = 3.5 A		31	39	mΩ
	RDS(on)2	Vgs = 4.0 V, Id = 3.5 A		32	40	mΩ
	RDS(on)3	Vgs = 2.5 V, Id = 3.5 A		40	54	mΩ
Input Capacitance	Ciss	V _{DS} = 10 V		470		pF
Output Capacitance	Coss	V _{GS} = 0 V		100		pF
Reverse Transfer Capacitance	Crss	f = 1.0 MHz		60		pF
Turn-on Delay Time	td(on)	Vdd = 10 V, Id = 3.5 A		35		ns
Rise Time	tr	V _{GS} = 4.0 V		110		ns
Turn-off Delay Time	$t_{d(off)}$	R _G = 10 Ω		170		ns
Fall Time	tr			130		ns
Total Gate Charge	QG	V _{DD} = 24 V		5.4		nC
Gate to Source Charge	Q _{GS}	V _{GS} = 4.0 V		1.1		nC
Gate to Drain Charge	Qgd	ID = 6.5 A		2.4		nC
Diode Forward Voltage	VF(S-D)	IF = 6.5 A, VGS = 0 V		0.9		V

TEST CIRCUIT 1 SWITCHING TIME

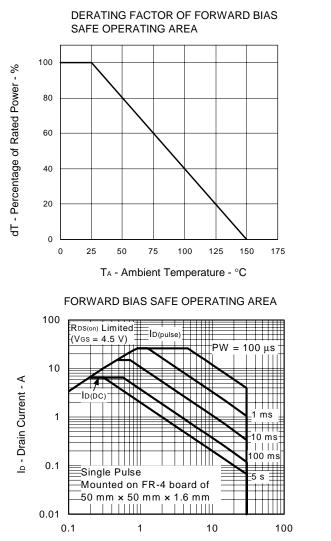


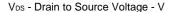
TEST CIRCUIT 2 GATE CHARGE

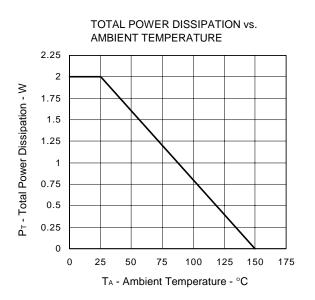


tf

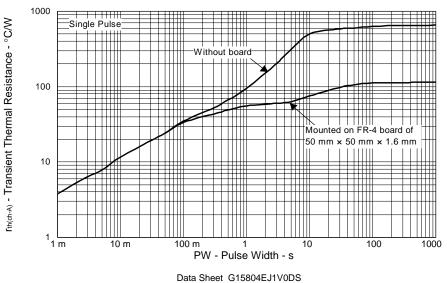
TYPICAL CHARACTERISTICS ($T_A = 25^{\circ}C$)

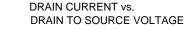


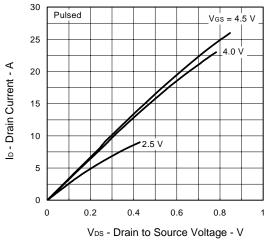


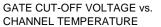


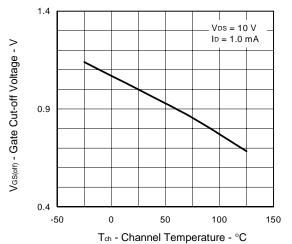


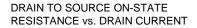


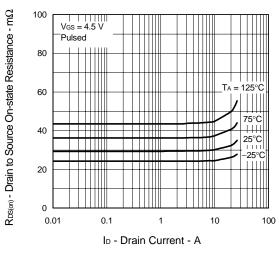




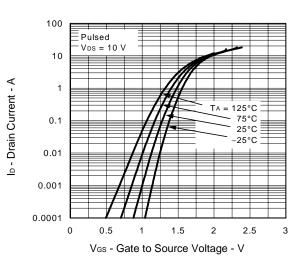




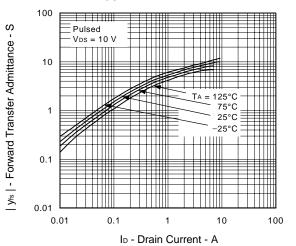




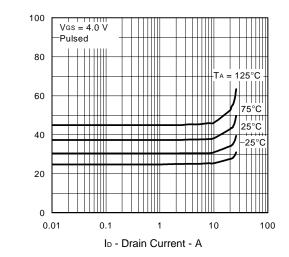
FORWARD TRANSFER CHARACTERISTICS



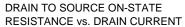
FORWARD TRANSFER ADMITTANCE vs. DRAIN CURRENT

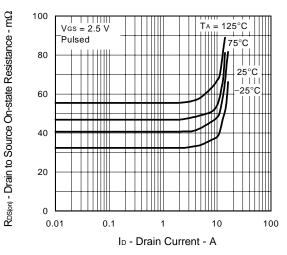


DRAIN TO SOURCE ON-STATE RESISTANCE vs. DRAIN CURRENT

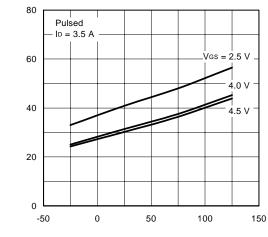


 $R_{DS(cn)}$ - Drain to Source On-state Resistance - m Ω





DRAIN TO SOURCE ON-STATE RESISTANCE vs. CHANNEL TEMPERATURE





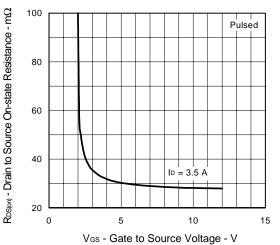


 $R_{DS(on)}$ - Drain to Source On-state Resistance - m Ω

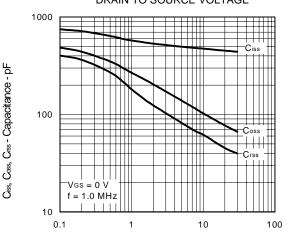


1000 1000 1000 1

DRAIN TO SOURCE ON-STATE RESISTANCE vs. GATE TO SOURCE VOLTAGE

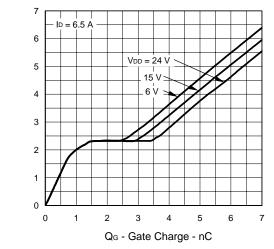


CAPACITANCE vs. DRAIN TO SOURCE VOLTAGE



VDs - Drain to Source Voltage - V

DYNAMIC INPUT/OUTPUT CHARACTERISTICS

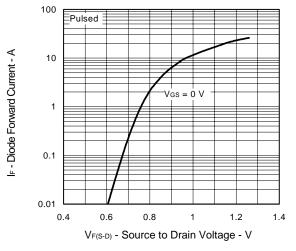


Data Sheet G15804EJ1V0DS

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Ves - Gate to Source Voltage - V

SOURCE TO DRAIN DIODE FORWARD VOLTAGE



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